8-bit bus switch with output enable

Rev. 1 — 30 December 2010

Product data sheet

1. General description

The 74CBTLV3245 is an 8-pole, single-throw bus switch. The device features a single output enable input (\overline{OE}) that controls eight switch channels. The switches are disabled when \overline{OE} is HIGH. Schmitt-trigger action at control inputs makes the circuit tolerant of slower input rise and fall times. This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

2. Features and benefits

- Supply voltage range from 2.3 V to 3.6 V
- High noise immunity
- Complies with JEDEC standard:
 - JESD8-5 (2.3 V to 2.7 V)
 - ◆ JESD8-B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
- 5 Ω switch connection between two ports
- Rail to rail switching on data I/O ports
- CMOS low power consumption
- Latch-up performance exceeds 250 mA per JESD78B Class I level A
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



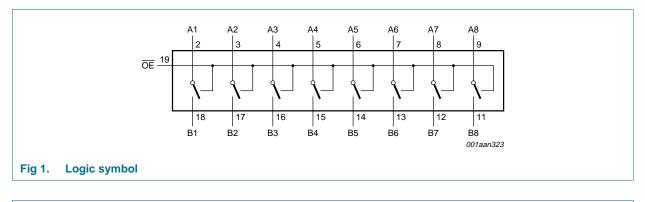
8-bit bus switch with output enable

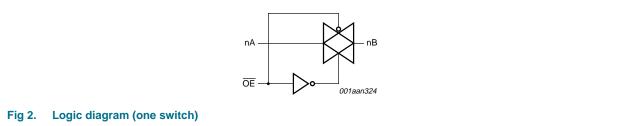
3. Ordering information

Table 1. Orderin	ng information			
Type number	Package			
	Temperature range	Name	Description	Version
74CBTLV3245DS	–40 °C to +125 °C	SSOP20 ^[1]	plastic shrink small outline package; 20 leads; body width 3.9 mm; lead pitch 0.635 mm	SOT724-1
74CBTLV3245PW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1
74CBTLV3245BQ	–40 °C to +125 °C	DHVQFN20	plastic dual-in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm	SOT764-1

[1] Also known as QSOP20 package

4. Functional diagram

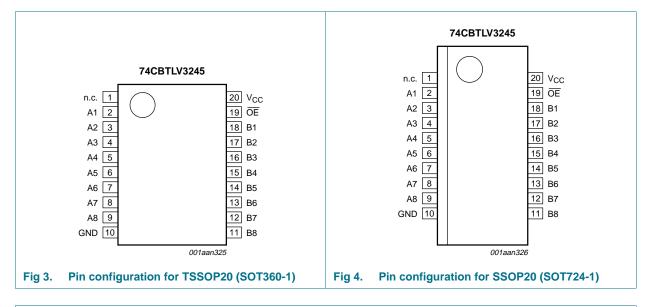


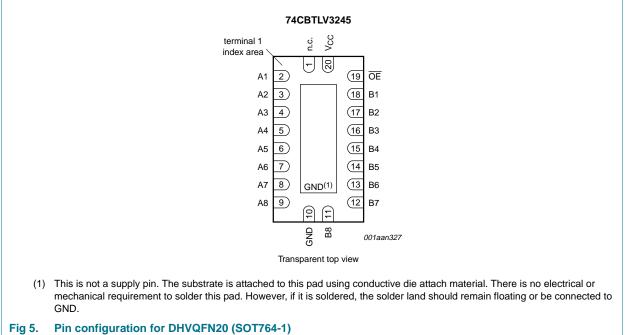


8-bit bus switch with output enable

5. Pinning information

5.1 Pinning





74CBTLV3245

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Product data sheet

8-bit bus switch with output enable

5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
nc	1	not connected
A1 to A8	2, 3, 4, 5, 6, 7, 8, 9	data input/output (A port)
GND	10	ground (0 V)
B1 to B8	18, 17, 16, 15, 14, 13, 12, 1 [,]	1 data input/output (B port)
OE	19	output enable input (active LOW)
V _{CC}	20	positive supply voltage

6. Functional description

Table 3.	Function selection ^[1]	
Input OE		Input/output
OE		An, Bn
L		An = Bn
Н		Z

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
V _{SW}	switch voltage	enable and disable mode	<u>[1]</u> –0.5	$V_{CC} + 0.5$	V
I _{IK}	input clamping current	$V_{I} < -0.5 V$	-50	-	mA
I _{SK}	switch clamping current	$V_{I} < -0.5 V$	-50	-	mA
I _{SW}	switch current	$V_{SW} = 0 V \text{ to } V_{CC}$	-	±128	mA
I _{CC}	supply current		-	+100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[2] _	500	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SSOP20 and TSSOP20 packages: above 60 °C the value of P_{tot} derates linearly at 5.5 mW/K.
 For DHVQFN20 packages: above 60 °C the value of P_{tot} derates linearly at 4.5 mW/K.

8-bit bus switch with output enable

8. Recommended operating conditions

Table 5.	Recommended operating condition	ons			
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		2.3	3.6	V
VI	input voltage		0	3.6	V
V _{SW}	switch voltage	enable and disable mode	0	V_{CC}	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 2.3 \text{ V to } 3.6 \text{ V}$	<u>[1]</u> _	200	ns/V
					-

[1] Applies to control signal levels.

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions voltages are referenced to GND (ground = 0 V).

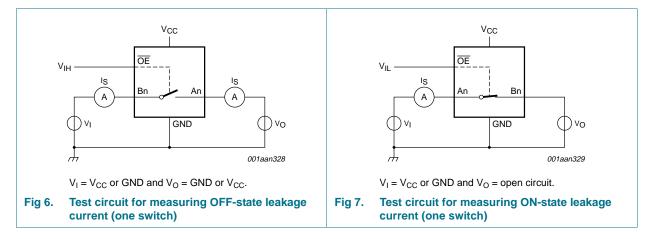
Symbol	Parameter	Conditions	T _{amb} =	–40 °C to	+85 °C	T _{amb} = −40 °	Unit	
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
V _{IH}	HIGH-level	V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
	input voltage	V_{CC} = 3.0 V to 3.6 V	2.0	-	-	2.0	-	V
V _{IL}		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
	voltage	V_{CC} = 3.0 V to 3.6 V	-	-	0.9	-	0.9	V
lı	input leakage current	pin \overline{OE} ; V _I = GND to V _{CC} ; V _{CC} = 3.6 V	-	-	±1	-	±20	μA
I _{S(OFF)}	OFF-state leakage current	V_{CC} = 3.6 V; see <u>Figure 6</u>	-	-	±1	-	±20	μΑ
I _{S(ON)}	ON-state leakage current	V_{CC} = 3.6 V; see <u>Figure 7</u>	-	-	±1	-	±20	μΑ
I _{OFF}	power-off leakage current	V_{I} or $V_{O} = 0$ V to 3.6 V; $V_{CC} = 0$ V	-	-	±10	-	±50	μΑ
I _{CC}	supply current		-	-	10	-	50	μA
ΔI_{CC}	additional supply current	$ \begin{array}{l} \mbox{pin } \overline{\text{OE}}; \ \mbox{V}_{I} = \mbox{V}_{CC} - 0.6 \ \mbox{V}; \\ \ \mbox{V}_{SW} = \mbox{GND or } \ \mbox{V}_{CC}; \\ \ \mbox{V}_{CC} = 3.6 \ \mbox{V} \end{array} $	[2] -	-	300	-	2000	μA
CI	input capacitance	pin \overline{OE} ; V _{CC} = 3.3 V; V _I = 0 V to 3.3 V	-	0.9	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance	V_{CC} = 3.3 V; V_{I} = 0 V to 3.3 V	-	5.2	-	-	-	pF
$C_{S(ON)}$	ON-state capacitance	V_{CC} = 3.3 V; V_{I} = 0 V to 3.3 V	-	14.3	-	-	-	pF

[1] All typical values are measured at T_{amb} = 25 °C.

[2] One input at 3 V, other inputs at V_{CC} or GND.

74CBTLV3245 Product data sheet

8-bit bus switch with output enable



9.1 Test circuits

9.2 ON resistance

Table 7. Resistance R_{ON}

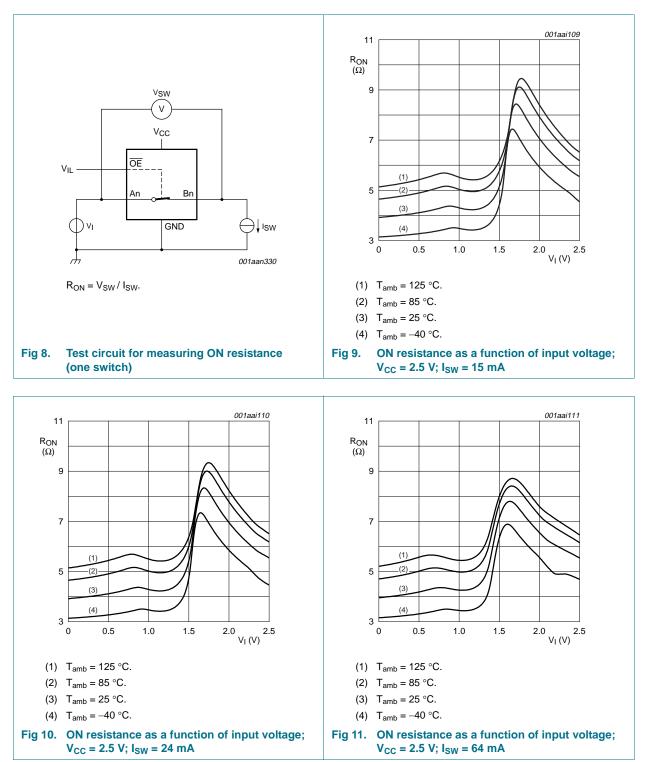
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8.

Symbol	Parameter	Conditions	T _{amb} =	–40 °C to	+85 °C	T _{amb} = −40 °	T_{amb} = -40 °C to +125 °C	
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
R _{ON}	ON resistance	$V_{CC} = 2.3 V \text{ to } 2.7 V;$ see Figure 9 to Figure 11	[
		$I_{SW} = 64 \text{ mA}; V_I = 0 \text{ V}$	-	4.2	8.0	-	15.0	Ω
		$I_{SW} = 24 \text{ mA}; V_I = 0 \text{ V}$	-	4.2	8.0	-	15.0	Ω
		$I_{SW} = 15 \text{ mA}; V_I = 1.7 \text{ V}$	-	8.4	40	-	60.0	Ω
	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V};$ see <u>Figure 12</u> to <u>Figure 14</u>							
		$I_{SW} = 64 \text{ mA}; V_I = 0 \text{ V}$	-	4.0	7.0	-	11.0	Ω
		$I_{SW} = 24 \text{ mA}; V_I = 0 \text{ V}$	-	4.0	7.0	-	11.0	Ω
		$I_{SW} = 15 \text{ mA}; V_I = 2.4 \text{ V}$	-	6.2	15	-	25.5	Ω

[1] Typical values are measured at T_{amb} = 25 $^\circ C$ and nominal $V_{CC}.$

[2] Measured by the voltage drop between the A and B terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

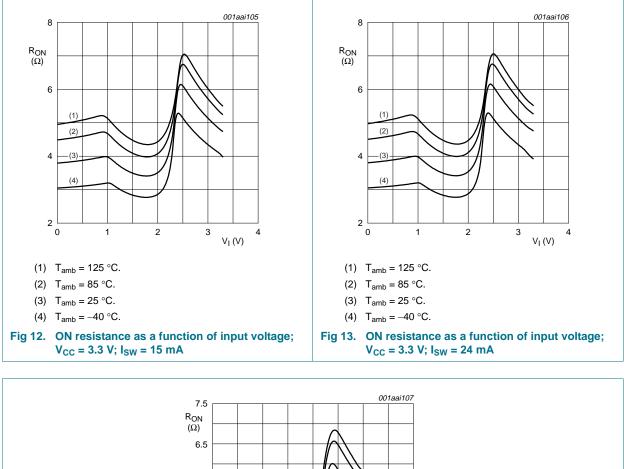
8-bit bus switch with output enable

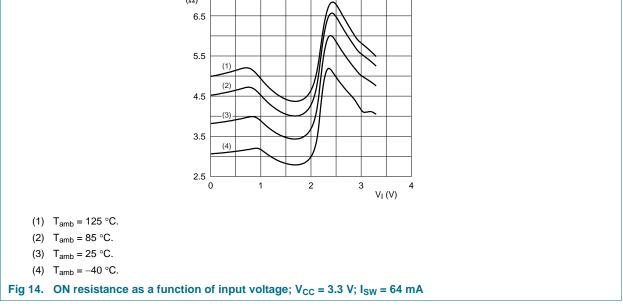


9.3 ON resistance test circuit and graphs

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8-bit bus switch with output enable





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10. Dynamic characteristics

Table 8. Dynamic characteristics

GND = 0 V; for test circuit see Figure 17

Symbol	Parameter	Conditions		T_{amb} = -40 °C to +85 °C		T_{amb} = -40 °C to +125 °C		Unit	
				Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	An to Bn or Bn to An; see <u>Figure 15</u>	<u>[2][3]</u>						
		V_{CC} = 2.3 V to 2.7 V		-	-	0.13	-	0.20	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	-	0.20	-	0.31	ns
t _{en} enable time	enable time	OE to An or Bn; see <u>Figure 16</u>	<u>[4]</u>						
		V_{CC} = 2.3 V to 2.7 V		1.0	3.4	5.5	1.0	8.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	3.0	4.9	1.0	7.0	ns
t _{dis} disable time		OE to An or Bn; see <u>Figure 16</u>	[5]						
		V_{CC} = 2.3 V to 2.7 V		1.0	3.0	5.5	1.0	8.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	3.4	5.8	1.0	8.5	ns

[1] All typical values are measured at T_{amb} = 25 °C and at nominal V_{CC}.

[2] The propagation delay is the calculated RC time constant of the on-state resistance of the switch and the load capacitance, when driven by an ideal voltage source (zero output impedance).

[3] t_{pd} is the same as t_{PLH} and t_{PHL} .

[4] t_{en} is the same as t_{PZH} and t_{PZL} .

[5] t_{dis} is the same as t_{PHZ} and t_{PLZ} .

11. Waveforms

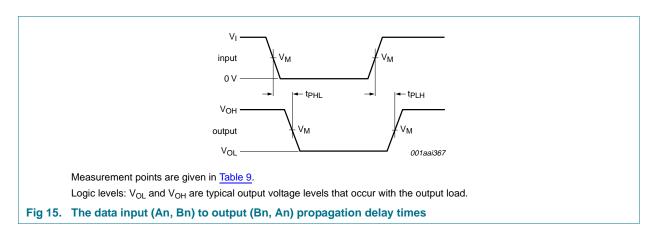


Table 9. Measurement points

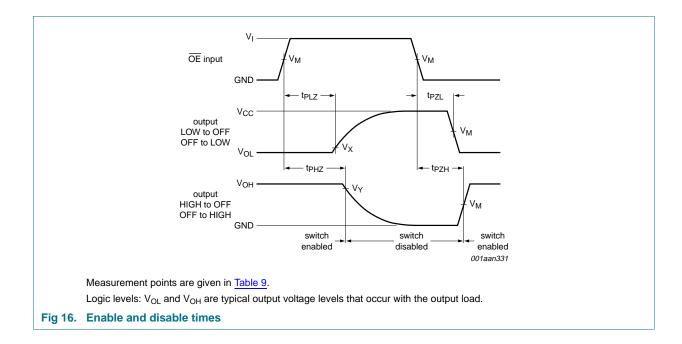
Supply voltage	Input			Output		
V _{CC}	V _M	VI	$t_r = t_f$	VM	V _X	V _Y
2.3 V to 2.7 V	$0.5V_{CC}$	V _{CC}	\leq 2.0 ns	$0.5V_{CC}$	V _{OL} + 0.15 V	$V_{OH} - 0.15 \ V$
3.0 V to 3.6 V	$0.5V_{CC}$	V _{CC}	\leq 2.0 ns	$0.5V_{CC}$	V _{OL} + 0.3 V	$V_{OH} - 0.3 \ V$

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Product data sheet	Rev. 1 — 30 December 2010	9 of 18

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74CBTLV3245

8-bit bus switch with output enable



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74CBTLV3245

8-bit bus switch with output enable

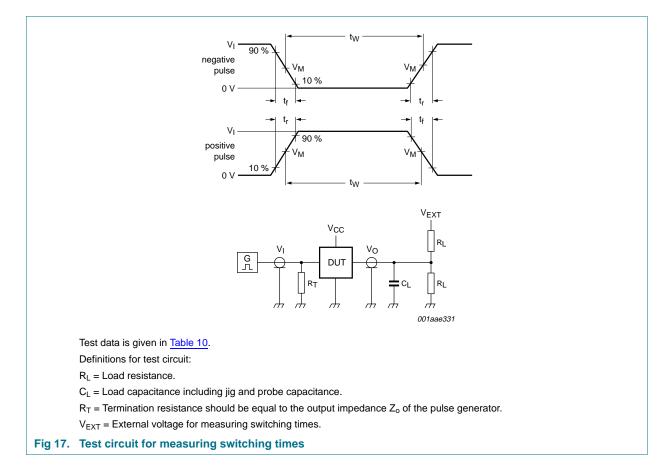


Table 10. Test data

Supply voltage	Load		V _{EXT}		
V _{CC}	CL	RL	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
2.3 V to 2.7 V	30 pF	500 Ω	open	GND	2V _{CC}
3.0 V to 3.6 V	50 pF	500 Ω	open	GND	2V _{CC}

8-bit bus switch with output enable

12. Package outline

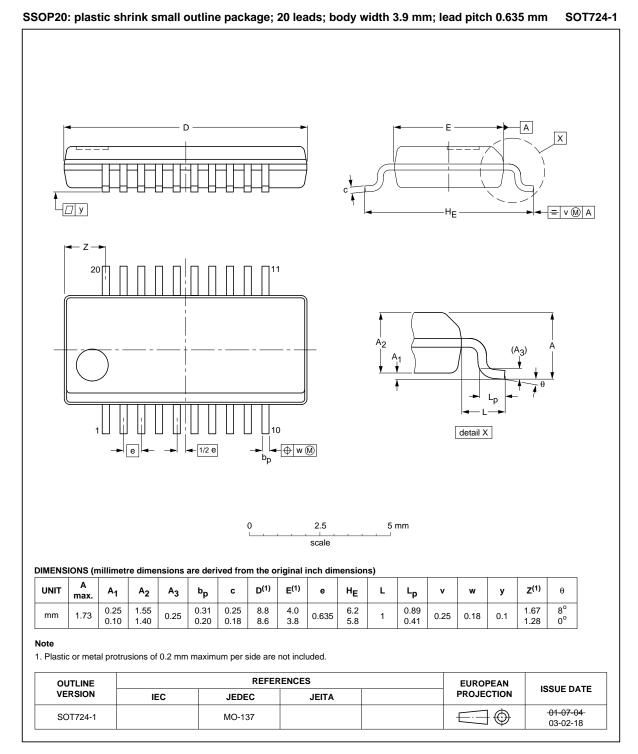


Fig 18. Package outline SOT724-1 (SSOP20)

74CBTLV3245 Product data sheet

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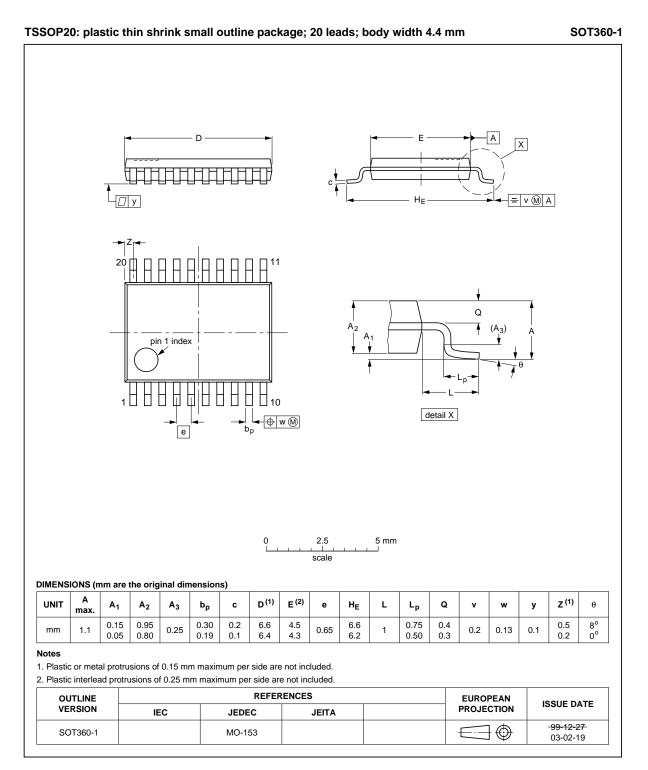
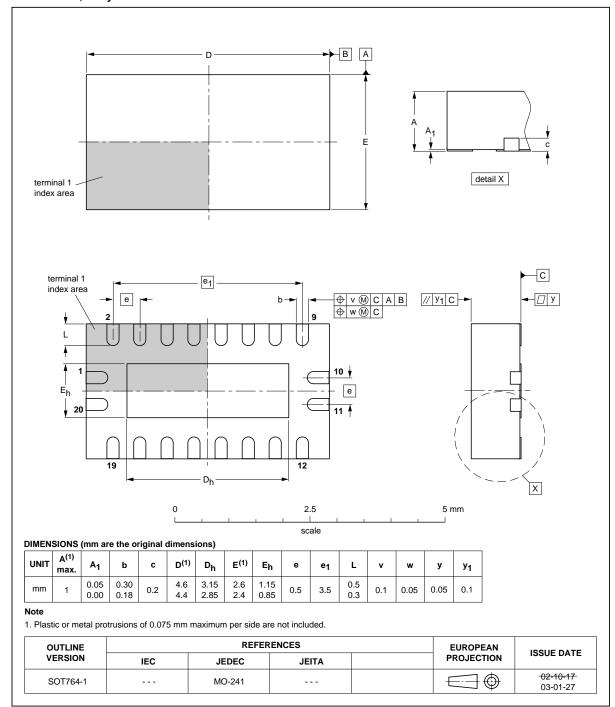


Fig 19. Package outline SOT360-1 (TSSOP20)

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74CBTLV3245

8-bit bus switch with output enable



DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 20. Package outline SOT764-1 (DHVQFN20)

74CBTLV3245 Product data sheet



8-bit bus switch with output enable

13. Abbreviations

Table 11.	Abbreviations
Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

14. Revision history

Table 12. Revision history						
Document ID	Release date	Data sheet status	Change notice	Supersedes		
74CBTLV3245 v.1	20101230	Product data sheet	-	-		

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
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8-bit bus switch with output enable

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8-bit bus switch with output enable

17. Contents

1	General description 1
2	Features and benefits 1
3	Ordering information 2
4	Functional diagram 2
5	Pinning information 3
5.1	Pinning 3
5.2	Pin description 4
6	Functional description 4
7	Limiting values 4
8	Recommended operating conditions 5
9	Static characteristics 5
9.1	Test circuits 6
9.2	ON resistance 6
9.3	ON resistance test circuit and graphs 7
10	Dynamic characteristics 9
11	Waveforms 9
12	Package outline 12
13	Abbreviations 15
14	Revision history 15
15	Legal information 16
15.1	Data sheet status 16
15.2	Definitions 16
15.3	Disclaimers 16
15.4	Trademarks 17
16	Contact information 17
17	Contents

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